

Patent

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Bassel H. DAOUD et al.

Serial No.:

09/497,045

Filed: February 2, 2000

For:

Mold Incorporating A Heat Source And

Apparatus And Method For Using Such Molds

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

Examiner: Mark Halpern

Group Art: 1731

June 23, 2004 (Date of Deposit)

Edward M. Weis

Signature

June 23, 2004 Date of Signature

Mail Stop **DRAWINGS** Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## LETTER WITH PROPOSED DRAWING CHANGES

SIR:

In response to the Notice Regarding Drawings dated May 11, 2004, Applicants hereby submit corrected drawings (sheets 1-12) which are believed to address all of the items listed on the Form PTO-948.

512327RCE.DWG

Any additional fees or charges required at this time in connection with the application may be charged to our Patent and Trademark Office Deposit Account No. 03-2412.

> Respectfully submitted, COHEN, PONTANI, LIEBERMAN & PAVANE

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